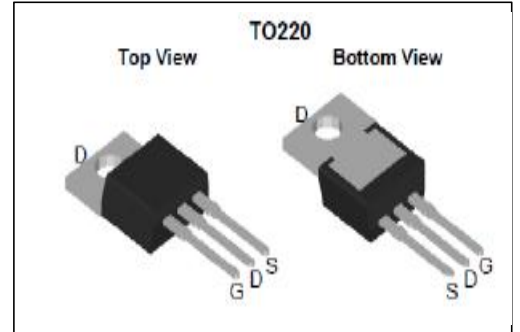




TO-220 Plastic-Encapsulate MOSFETS

CCMB100N10S N-Channel Power MOSFET

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
100V	6.8 mΩ@10V	100A



DESCRIPTION

The CCMB100N10S uses advanced SGT technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

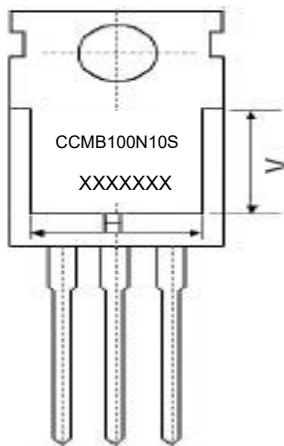
FEATURE

- Extremely low on-resistance $R_{DS(on)}$
- Excellent $Q_g \times R_{DS(on)}$ product(FOM)
- Qualified according to JEDEC criteria
- AEC Q101 Qualified

APPLICATION

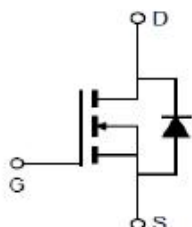
- Motor control and drive
- Battery management
- UPS(Uninterruptible Power Supplies)

MARKING



CCMB100N10S =Part No.
XXXXXXX = Code

EQUIVALENT CIRCUIT



ABSOLUTE MAXIMUM RATINGS(TC=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	100	V
Gate-Source Voltage	V _{GS}	±25	V
Continuous Drain Current	I _D	100	A
Pulsed Drain Current ¹	I _{DM}	400	A
Single Pulse Avalanche Energy ²	E _{AS}	20	mJ
Total Power Dissipation	P _D	192	W
Thermal Resistance from Junction to Case	R _{θJC}	0.78	°C/W
Operating Junction and Storage Temperature Range	T _J , T _{STG}	-55~+175	°C
Soldering Temperature , for 10S(1.6mm from case)	-	260	°C

Notes:

1.Repetitive Rating: Pulse width limited by maximum junction temperature.

2.EAS condition : T_j=25°C,L=0.1mH,R_g=25Ω,I_{as}=20A.

MOSFET ELECTRICAL CHARACTERISTICS

TC=25°C unless otherwise specified

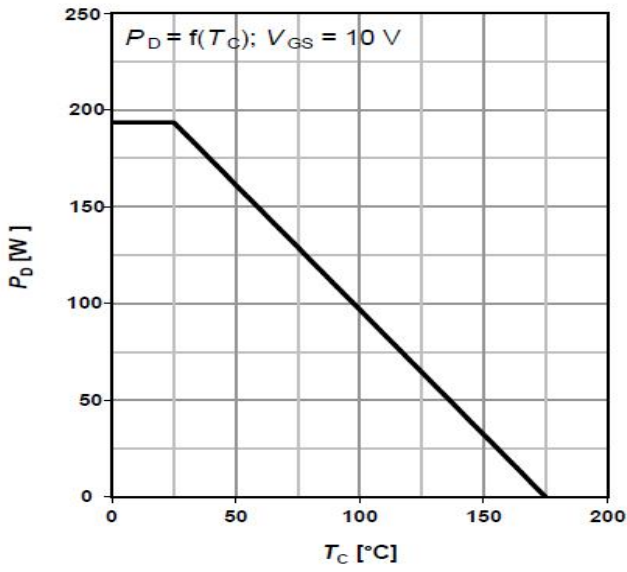
Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Off characteristics						
Drain-Source breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 μA		100		V
Zero gate voltage drain current	I _{DSS}	V _{DS} = 100V, V _{GS} = 0 V			1	μA
Gate-body leakage current	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±25 V		±10	±100	nA
On characteristics						
Gate threshold voltage ³	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	1.5	2.0	3.0	V
Drain-source on-resistance ³	R _{DS(on)}	V _{GS} = 10 V, I _D = 50 A		6.8	8.0	mΩ
Transconductance	g _{fs}	V _{DS} =10V, I _D =10A		58		S
Dynamic characteristics¹						
Input Capacitance	C _{iss}	V _{DS} = 25V, V _{GS} = 0 V, f = 1 MHz		2960		pF
Output Capacitance	C _{oss}			1036		
Reverse Transfer Capacitance	C _{rss}			139		
Gate resistance	R _g	V _{GS} = 0V, V _{DS} =0V, f=1MHz		1.18		Ω
Switching characteristics¹						
Total Gate Charge	Q _g	V _{DD} = 50 V, V _{GS} = 10 V, I _D = 50 A, f = 1 MHz		105		nC
Gate-Source Charge	Q _{gs}			22		
Gate-Drain Charge	Q _{gd}			36		
Turn-on delay time	t _{d(on)}	V _{DD} = 50 V, V _{GS} = 10 V, R _G = 2.7Ω		18		ns
Turn-on rise time	t _r			80		
Turn-off delay time	t _{d(off)}			52		
Turn-off fall time	t _f			91		
Drain-Source Diode Characteristics						
Drain-source diode forward Voltage ³	V _{SD}	V _{GS} = 0V, I _{SD} = 50A, T _j = 25 °C		0.9	1.4	V
Continuous drain-source diode forward current ²	I _S	T _c = 25 °C			100	A
Pulsed drain-source diode forward current	I _{SM}	—			400	A
Reverse recovery time	t _{rr}	I _F =100A, dI/dt=100A/us		50		ns
Reverse recovery charge	Q _{rr}				102	

Notes :

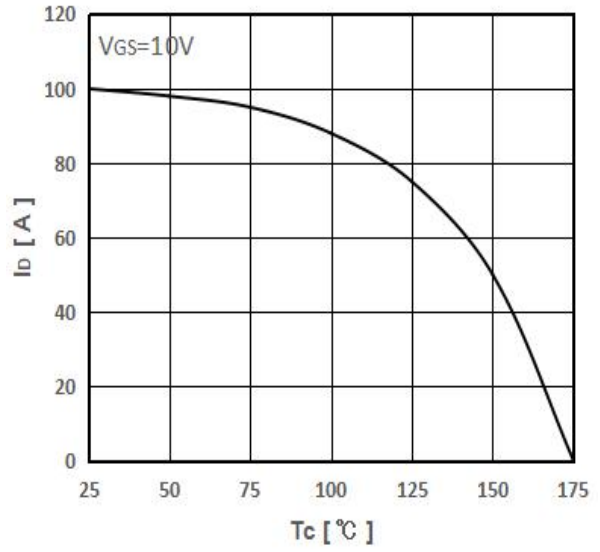
1. Guaranteed by design, not subject to production.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.

Typical Characteristics

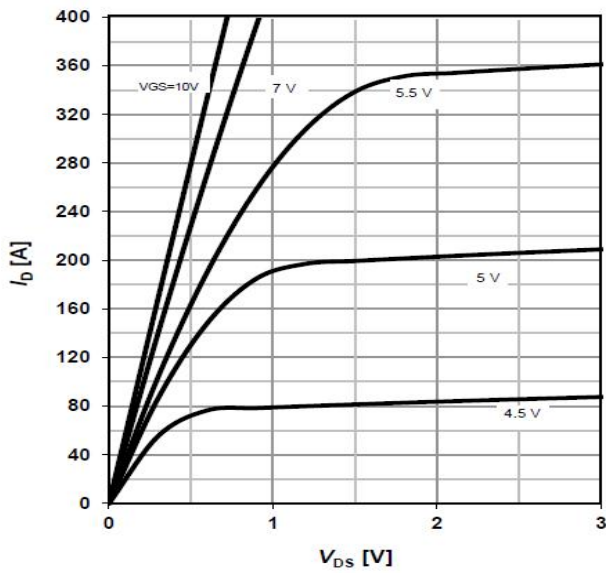
PD -- Tc



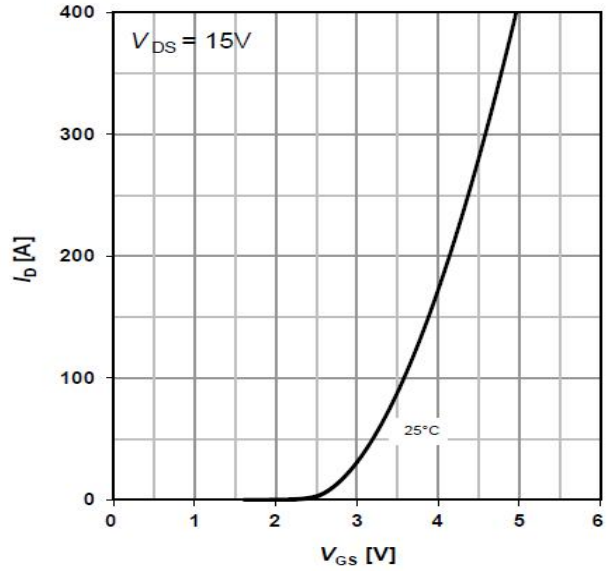
ID -- Tc



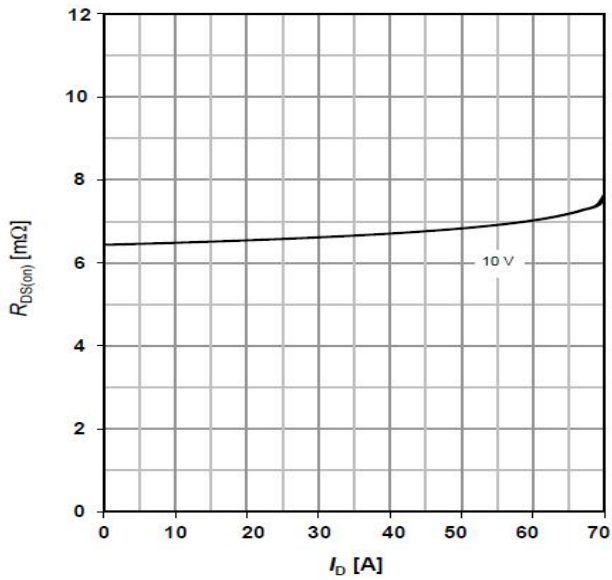
ID -- VDS



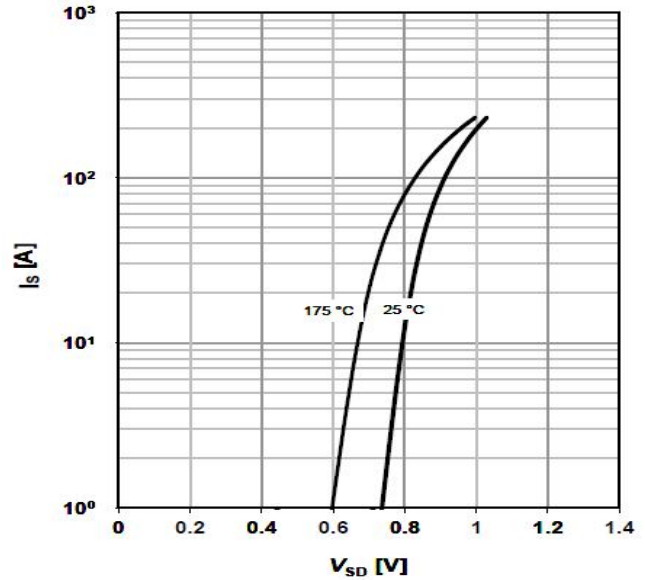
ID -- VGS



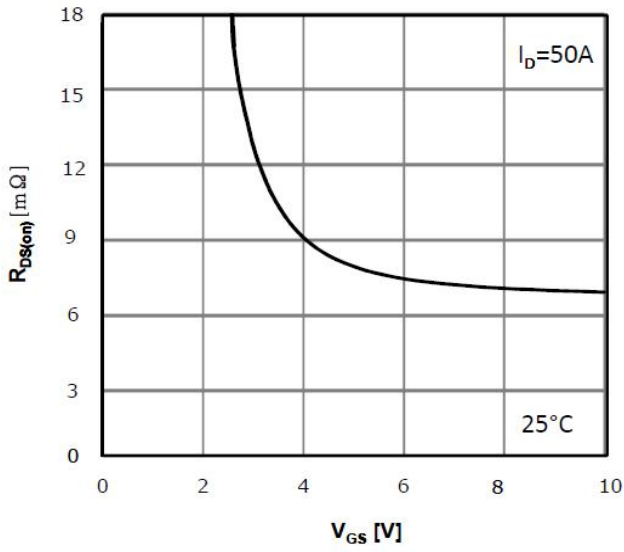
RDS(on) -- ID



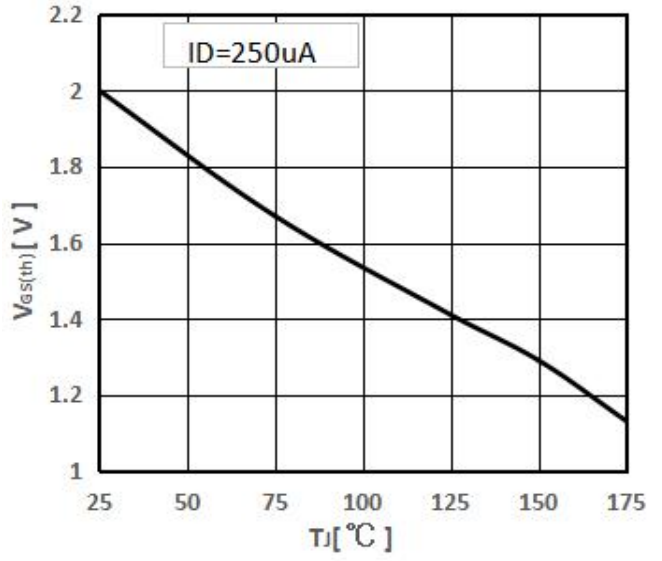
IS -- VSD



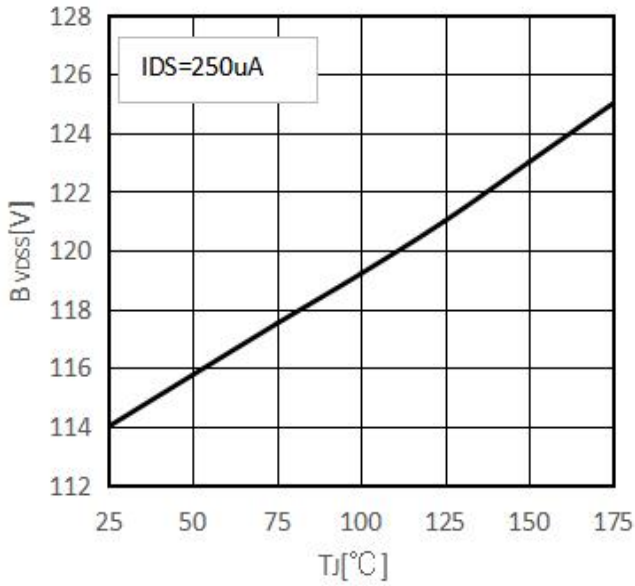
RDS(on) -- VGS



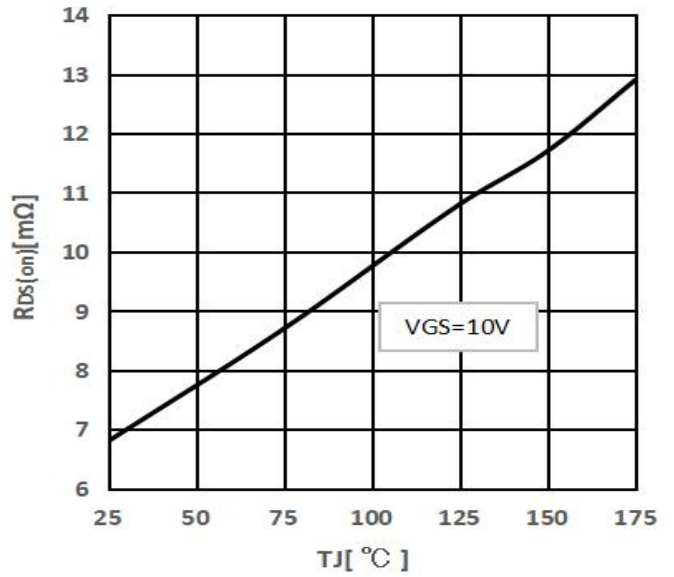
Threshold Voltage



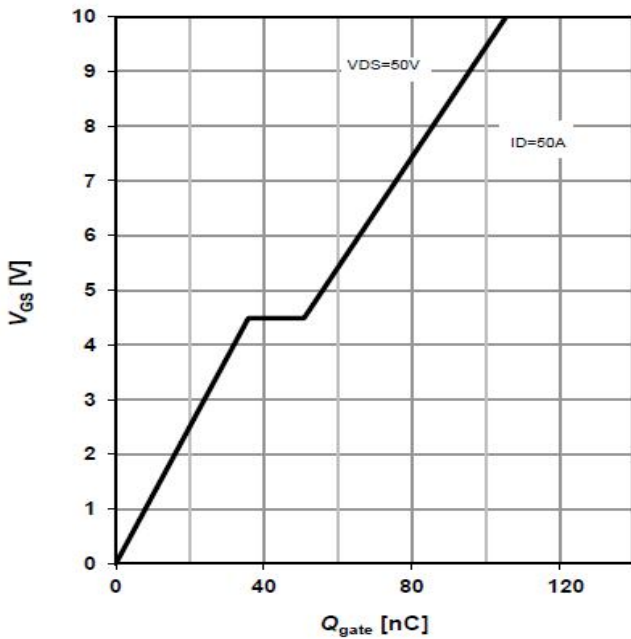
Drain-source breakdown voltage



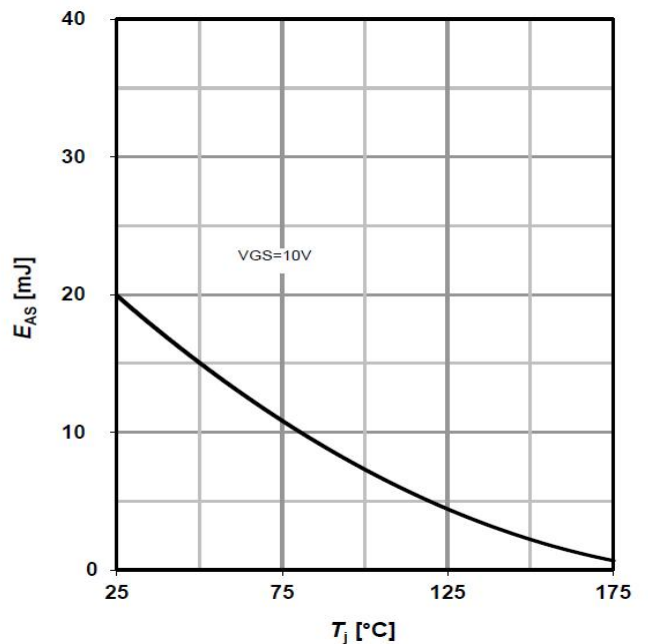
RDS (on) -- TJ



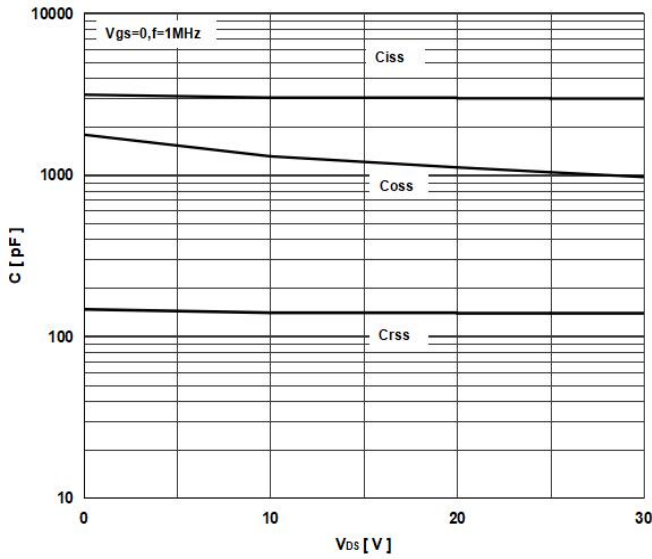
Typ.gate charge



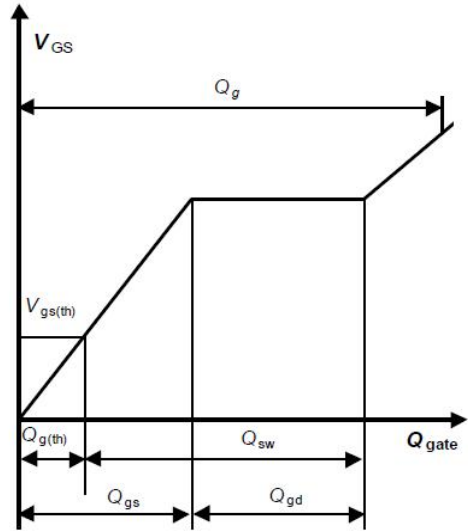
Avalanche energy



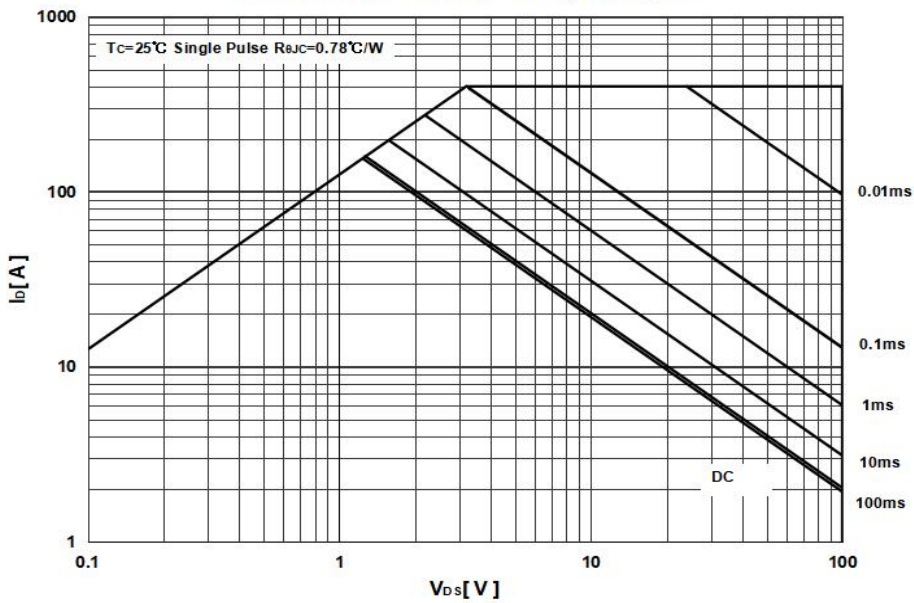
Typ. capacitance



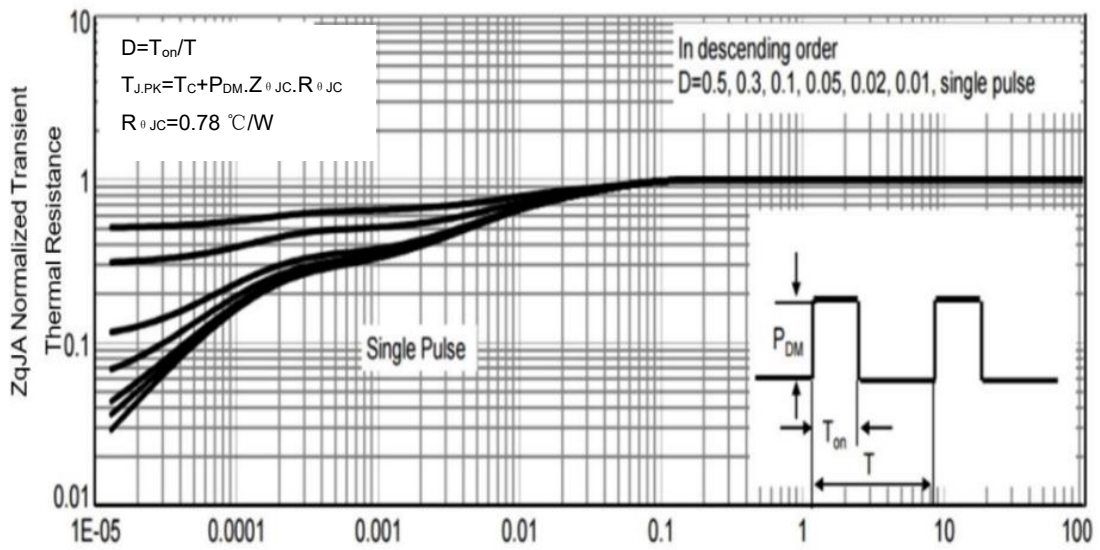
Gate charge waveforms



Maximum Forward Biased Safe Operating Area

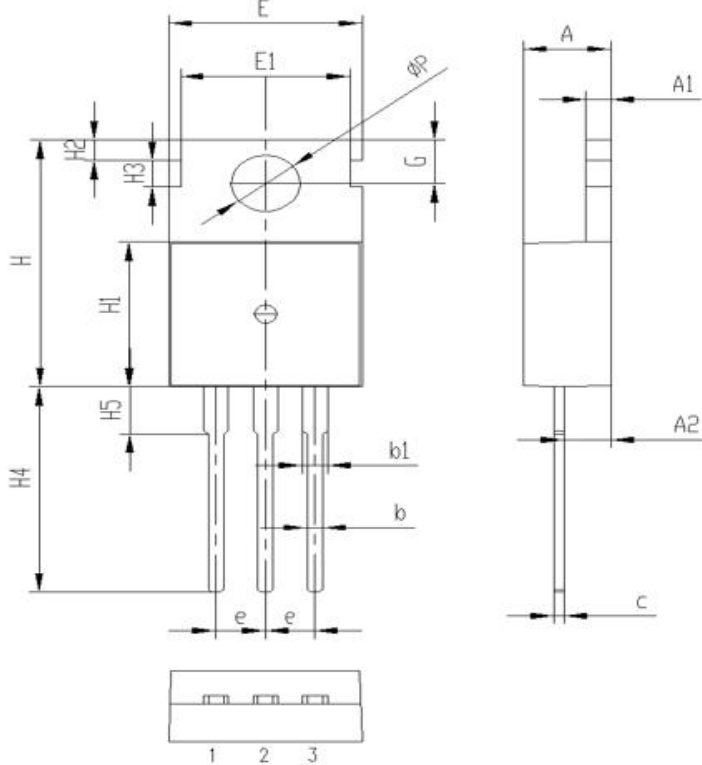


Normalized Thermal Transient Impedance



TO-220 Package Outline Dimensions

外形名称: TO-220C



Symbol	单位 mm		
	Min	Nom	Max
A	4.30	4.5	4.70
A1	1.17	1.27	1.37
A2	2.20	2.4	2.60
b	0.60	0.8	1.00
b1	1.17	1.27	1.37
b2	1.90	2.1	2.30
c	0.40	0.5	0.60
e	2.44	2.54	2.64
E	9.90	10	10.1
E1	8.50	8.7	8.90
H	15.5	15.7	15.9
H1	9.00	9.2	9.40
H2	1.10	1.3	1.50
H3	1.50	1.7	1.90
H4	12.8	13.2	13.6
H5	2.80	3.0	3.20
G	2.60	2.8	3.00
ΦP	3.40	3.6	3.80

基本尺寸

TO-220-2L Tubing



Tubing	Box	Box Size(mm)	Carton	Carton Size(mm)
50pcs	1000pcs	575*152*48	5000pcs	590*275*175

NOTICE

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Date of change	Rev #	revise content
2022/12/06	A/0	/